

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
In re the application of

Gangshan XU et al.

Application No. 09/752,509

Filed: December 27, 2000

For: METHODS FOR MAKING  
REINFORCED WAFER POLISHING  
PADS AND APPARATUSES  
IMPLEMENTING THE SAME

Examiner: Not Assigned

Art Unit: 1733

Docket No. LAM2P223A

Date: November 27, 2001

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on November 27, 2001.

Signed: 

Diane Schwanbeck

**REQUEST TO RESCIND PREVIOUS NONPUBLICATION REQUEST**  
**35 U.S.C. 122(b)(2)(B)(ii)**

Commissioner for Patents  
Washington, D.C. 20231

**MAILED**

APR 29 2002

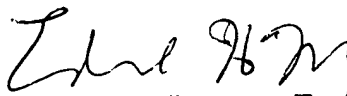
COPY OF PAPERS  
ORIGINALLY FILED

Sir:

I hereby **rescind** the previous request that the above-identified application not be published under 35 U.S.C. 122(b).

**GROUP 1700**

Respectfully submitted,  
MARTINE & PENILLA, LLP

  
Edmund H. Mizumoto, Esq.  
Reg. No. 46,938

710 Lakeway Drive, Suite 170  
Sunnyvale, CA 94085  
(408) 749-6900  
Customer Number 25920

**RECEIVED**

AUG 23 2004

TECHNOLOGY CENTER R3700

Attorney Docket No. LAM2P223A